Wire-wound Metal Power Inductors MCOIL[™] LBDN series for Telecommunications Infrastructure and Industrial Equipment Wire-wound Metal Power Inductors MCOIL[™] LMDN series for Medical Devices classified as GHTF Class C (Japan Class III)

RELIABILITY DATA

1. Operating Temperature Range		
Specified Value	$-40 \sim +125^{\circ} C$ (Including self-generated heat)	
Test Methods and Remarks	Including self-generated heat	

2. Storage Tempera	2. Storage Temperature Range	
Specified Value	-40~+85°C	
Test Methods and Remarks	-5 to 40°C for the product with taping.	

3. Rated current	
Specified Value	Within the specified tolerance

4. Inductance		
Specified Value	Within the specified tolerance	
Test Methods and Remarks	Measuring equipment Measuring frequency	: LCR Meter(HP 4285A or equivalent) : 1MHz 1V (4040F:100kHz 1V)

5. DC Resistance		
Specified Value	Within the specified tolerance	
Test Methods and Remarks	Measuring equipment : DC ohmmeter (HIOKI 3227 or equivalent)	

6. Self resonance frequency		
Specified Value	-	

7. Temperature characteristic		
Specified Value	Inductance change : Within $\pm 10\%$	
Test Methods and Remarks	Measurement of inductance shall be taken at temperature range within $-40^{\circ}C \sim +125^{\circ}C$. With reference to inductance value at $+20^{\circ}C$., change rate shall be calculated.	

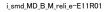
8. Resistance to flexure of substrate			
Specified Value	No damage		
Test Methods and Remarks	The test samples shall be s until deflection of the test Test board size Test board material Solder cream thickness	•	w. As illustrated below, apply force in the direction of the arrow indicating Force Rod $10 \xrightarrow{20}$ Res Board R5 $45\pm 2mm$

9. Insulation resistance : between wires		
Specified Value	-	
10. Insulation resistance : between wire and core		

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Specified Value

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11. Withstanding voltage : between wire and		
Specified Value	-	

12. Adhesion of terminal electrode			
Specified Value	Shall not come off PC board		
	The test samples shall be soldered to the test board by the reflow.		
Test Methods and	Applied force	: 10N to X and Y directions.	
Remarks	Duration	: 5s.	
	Solder cream thickness	: 0.1mm.	

13. Resistance to vibration			
Specified Value	Inductance change : Within $\pm 10\%$ No significant abnormality in appearance.		
	The test samples shall be s Then it shall be submitted Frequency Range	soldered to the test board by the reflow. to below test conditions. 10~55Hz	
Test Methods	Total Amplitude	1.5mm (May not exceed acceleration 196m/s ²)	
and Remarks	Sweeping Method	10Hz to 55Hz to 10Hz for 1min.	
and Remarks	Time	X Y For 2 hours on each X, Y, and Z axis. Z	
	Recovery : At least 2hrs of recovery under the standard condition after the test, followed by the measurement within 48hrs.		

14. Solderability				
Specified Value	At least 90% of surface of terminal electrode is covered by new solder.			
T . M	The test samples shall be dipped in flux, and then immersed in molten solder as shown in below table. Flux : Ethanol solution containing rosin 25%.			
Test Methods and Remarks	Solder Temperature	245±5°C		
Remarks	Time	5±1.0 sec.		
	XImmersion depth : All sides of mounting terminal shall be immersed.			

15. Resistance to soldering heat			
Specified Value	Inductance change : Within $\pm 10\%$ No significant abnormality in appearance.		
Test Methods and Remarks	The test sample shall be exposed to reflow oven at 230±5°C for 40 seconds, with peak temperature at 260±5°C for 5 seconds, 2 times. Test board material : glass epoxy-resin Test board thickness : 1.0mm		

16. Thermal shock						
Specified Value		Inductance change : Within $\pm 10\%$ No significant abnormality in appearance.				
		•	pelow table in sequence. The t	he test samples shall be placed at specified temperature for specified emperature cycle shall be repeated 1000 cycles.		
Test Methods	Step	Temperature (°C)	Duration (min)			
and Remarks	1	-40 ± 3	30±3			
	2	Room temperature	Within 3			
	3	$+85\pm2$	30±3			
	4	Room temperature	Within 3			

17. Damp heat			
Specified Value	Inductance change : Within $\pm 10\%$ No significant abnormality in appearance.		
Test Methods	The test samples shall be soldered to the test board by the reflow. The test samples shall be placed in thermostatic oven set at specified temperature and humidity as shown in below table.		
and Remarks	Temperature	60±2°C	
	Humidity	90~95%RH	
	Time	1000+24/-0 hour	

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18. Loading under	damp heat		
Specified Value	Inductance change : Within $\pm 10\%$ No significant abnormality in appearance.		
The test samples shall be soldered to the test board by the reflow. The test samples shall be placed in thermostatic oven set at specified temperature and humidity and applied the Test Methods as shown in below table.		•	
and Remarks	Temperature Humidity	60±2℃ 90~95%RH	
	Applied current	Rated current	

19. Low temperatur	re life test		
Specified Value	Inductance change : Within $\pm 10\%$ No significant abnormality in appearance.		
Test Methods	The test samples sha in below table.	ll be soldered to the test b	board by the reflow. After that, the test samples shall be placed at test conditions as shown
and Remarks	Temperature	-40±2°C	
	Time	1000 + 24 / -0 hour	

20. High temperature life test			
Specified Value	-		

21. Loading at high	temperature life test		
Specified Value	Inductance change : Within $\pm 10\%$ No significant abnormality in appearance.		
Test Methods	The test samples shall be soldered to the test board by the reflow. The test samples shall be placed in thermostatic oven set at specified temperature and applied the rated current continuously as shown in below table.		
and Remarks	Temperature	85±2°C	
	Applied current	Rated current	
	Time	1000 + 24 / -0 hour	

22. Standard condit	tion
Specified Value	Standard test condition : Unless otherwise specified, temperature is 20±15°C and 65±20% of relative humidity. When there is any question concerning measurement result: In order to provide correlation data, the test shall be condition of 20±2°C of temperature, 65±5% relative humidity. Inductance is in accordance with our measured value.

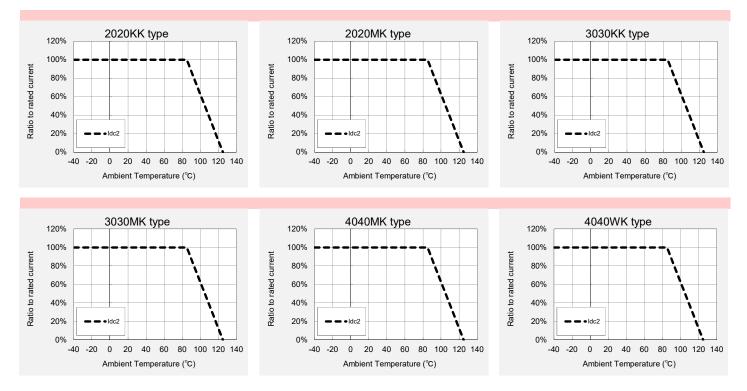
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Derating of Rated Current

LBDN series

Derating of current is necessary for LBDN series depending on ambient temperature. Please refer to the chart shown below for appropriate derating of current.



Derating of Rated Current

LMDN series

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